

## Class-AB Speaker Amplifiers

# 2W + 2W Stereo

# Speaker / Headphone Amplifier


**BH7881EFV**

No.10077EAT05

**●Description**

The BH7881EFV is a low voltage, low noise, high output speaker/headphone amplifier IC, in which a Bi-CMOS process is used. An on-chip speaker amplifier circuit that is capable of 2W+2W output can be used as a headphone amplifier by switching the operating mode. This makes it possible to configure an audio system using few external devices.

With a built-in, low saturation regulator with programmable output voltage and output current, clear tone quality is obtained even when directly connected to a digital power supply. A peripheral analog circuit can also be regulator driven. Furthermore, the BH7881EFV provides speaker output and VREG output short-circuit detection functions, a thermal shutdown function with hysteresis, and a speaker protection function.

**●Features**

- 1) Built-in low saturation type regulator (Digital power supply driver, voltage and current variable, short circuit detection)
- 2) Bass boost mode, gain switching functions
- 3) Speaker MUTE function (Headphone mode)
- 4) Built-in line amplifier output (gain adjustment, LPF setting) active/suspend function (TTL input control pin)
- 5) Hysteretic thermal shutdown function (Set for approximately 150°C /90°C)
- 6) IC protection function (SP pin VCC/GND short circuit detection)
- 7) Speaker protection function (Output voltage amplitude control)

**●Applications**

Notebook computers, LCD TVs, etc.

**●Absolute maximum ratings (Ta=25°C)**

Parameter	Ratings	Unit
Supply voltage	+6.0	V
Power dissipation	1100 *1	mW
Storage temperature	-55~+125	°C
Operating temperature	-10~+70	°C

\*1 Reduced by 11 mW/°C at 25°C or higher, when mounting on a 70mmX70mmX1.6mm PCB board).

**●Operating Conditions (Ta=25°C)**

Parameter	Ratings	Unit
Supply voltage	+3.3~+5.5	V

\* This IC is not designed to be radiation-resistant.

● **Electrical characteristics** (Unless otherwise noted, VCC=3.3V, Ta=25°C, f=1kHz, R=4Ω, 400Hz~30kHzBPF)

Parameter	Limits			Unit	Conditions
	Min.	Typ.	Max.		
<b>■ 1CHIP</b>					
Circuit current (ACTIVE)	-	18	30	mA	No signal
Circuit current(SUSPEND)	-	0	10	μA	No signal
<b>■ SP AMP</b>					
Voltage gain1	8.5	11.0	13.5	dB	SE, Vin=-18dBV
Voltage gain 2	14.5	17.0	19.5	dB	BTL, Vin=-18dBV
Distortion	-	0.04	1.0	%	BTL, Vin=-18dBV
Maximum output level	1.5	4.5	-	dBV	BTL, DSTN=1%
Output noise level	-	-90	-80	dBV	SE, DIN-Audio
Cross talk	-	-85	-75	dBV	SE, DIN-Audio
Output level on mute	-	-110	-80	dBV	BTL, Vin=-18dBV
<b>■ HP AMP</b>					
Voltage gain	3.0	5.5	8.0	dB	SE, Vin=-18dBV, RL=32Ω
Distortion	-	0.02	1.0	%	SE, Vin=-18dBV, RL=32Ω
Maximum output level	-1.6	1.4	-	dBV	SE, DSTN=1% , RL=10kΩ
Output noise level	-	-95	-80	dBV	SE, DIN-Audio , RL=32Ω
Cross talk	-	-90	-80	dBV	SE, DIN-Audio , RL=32Ω
Output level on mute	-	-105	-80	dBV	SE, Vin=-18dBV, RL=32Ω
<b>■ BIAS</b>					
Output voltage	1.40	1.65	1.90	V	No signal
<b>■ Regulator</b>					
Output voltage	2.7	3.0	-	V	No signal
PSRR	-	-80	-	dBV	VIN=0.28Vpp, 1kHz
<b>■ CONTROL PIN</b>					
ACTV/SPND CTRL 2PIN control pin					
SUSPEND mode	VCC/3+0.8	-	VCC	V	SP/HP&REG SUSPEND
ACTIVE mode	0	-	0.8	V	SP/HP&REG ACTIVE
SP/HP CTRL 12PIN control pin					
SP&HP mode	VCC/3+0.8	-	VCC	V	SP/HP ON
HP(SP MUTE) mode	0	-	0.8	V	SP OFF(SP MUTE), HP ON
BASSBOOST CTRL 11PIN control pin					
Bass-Boost mode	VCC/3+0.8	-	VCC	V	SP/HP gain UP
Non-Boost mode	0	-	0.8	V	SP/HP gain NORMAL

●Block diagram

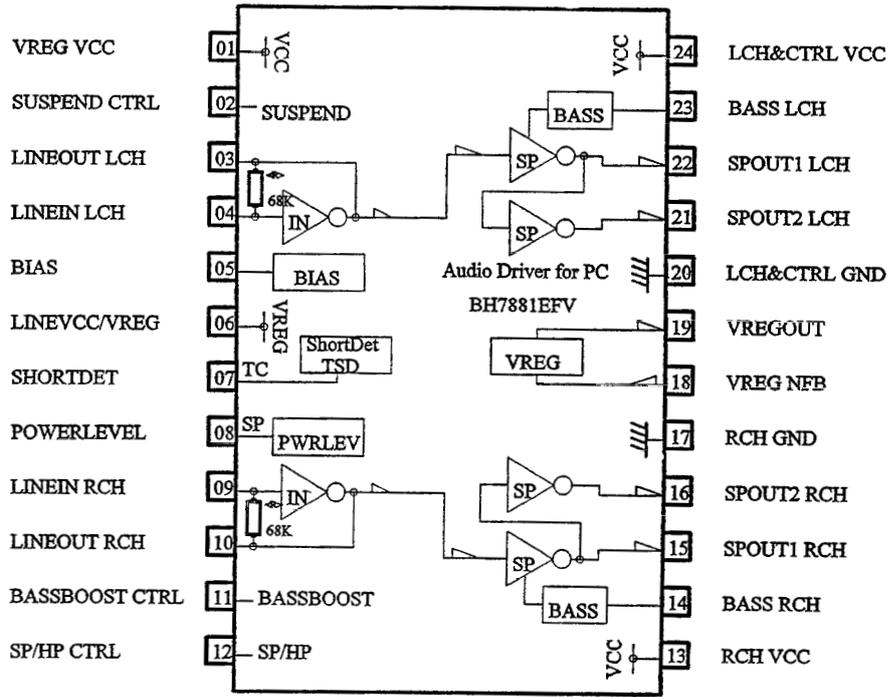


Fig.1

●Control pin descriptions

1. ACTIVE/SUSPEND:2PIN

Control input	Mode	Function
H	SUSPEND	Suspended state (Except REG)
L	ACTIVE	Active state

When suspended, the regulator (REG) is in an active state and the SP/HP/LINE amplifier is in a suspended state. Originally, signals from input resistance and feedback resistance leaked into the speaker output even when suspended, because of the series connection of an inverting amplifier. However, since the signals are cut off on their way in this IC, signal leaks do not occur in speaker output. (Signals due to feedback resistance are output in LINE amplifier output.)

2. POWER LEVEL:8PIN

Control input	Mode	Function
H	Limiter H	3Vf peak limiter ON (Output approx. 1.25 W)
OPEN	Limiter L	2Vf peak limiter ON(Output approx .0.70W)
L	Limiter OFF	limiter OFF

\*VCC=5V,RL=4ohm,VIN=-8dBV

Since a limiter uses diode characteristics, it has temperature characteristics. On the high temperature side, amplitude tends to decrease, which is a characteristic that protects the IC. Since setting in speaker mode is assumed, it is ineffective (limiter OFF) in headphone mode. Moreover, precautions must be taken when input is so great, that output becomes a square wave, since this could cause local oscillation.

3. BASSBOOST ON/OFF:11PIN

Control input	Mode	Function
H	ON	BASSBOOST:ON
L	OFF	BASSBOOST:OFF

The capacitor that constitutes BASSBOOST is eliminated, and also functions as a gain switch.

4. SP/HP:12PIN

Control input	Mode	Function
H	SP+HP	SP:ON, HP:ON
L	HP	SP:OFF,HP:ON

By using the headphone mode in a speaker MUTE mode, it is possible to completely cut off the pop noise when switching when VCC ON or OFF, or to ACTV or SPND. For control sequence and other information, see the following pages.

\*Not all control pins have pull up or pull down internal resistors. Therefore add pull up or pull down resistors, accordingly (PIN8 is an exception.)

## ●Description of operations

### 1. LINE Amplifier

- 1) The voltage gain of the LINE amplifier is calculated by the following equations:

$$\text{GAIN} = 20 \times \text{LOG}(68\text{k}/R4 + 1\text{k}) \text{ [dB]}$$

$$\text{GAIN} = 20 \times \text{LOG}(68\text{k}/R9 + 1\text{k}) \text{ [dB]} \quad R4 \text{ and } R9 \text{ are resistances connected to PIN4 and PIN9}$$

- 2) In order to make it operable with mixing input, the LINE amplifier can be realized by connecting multiple resistors to PIN4 and PIN9. Since the input pin is also the feedback of an inverting differential amplifier, each individual signal is simply added.
- 3) To configure LPF and remove unnecessary frequency components, the LINE amplifier can be realized by connecting capacitors between PIN3 and PIN4, and between PIN9 and PIN10. The LPF cut-off frequency at that time is calculated by the following equation:

$$f_c = 1/(2 \times \pi \times C \times 68\text{k}) \text{ [Hz]}$$

### 2. SP Amplifier (HP Amplifier)

- 1) The voltage gain of the SP amplifier for Non-Boost is about 12 [dB] (SE: Single end).

- 2) The voltage gain of the SP amplifier for Bass-Boost is calculated by the following equations:

$$\text{GAIN} = 20 \times \text{LOG}((40\text{k}+R22-23)/10\text{k}) \text{ [dB]} \quad \text{Where } R22-23 \text{ is the resistance connected between PIN22 and PIN23.}$$

$$\text{GAIN} = 20 \times \text{LOG}((40\text{k}+R14-15)/10\text{k}) \text{ [dB]} \quad \text{Where } R14-15 \text{ is the resistance connected between PIN14 and PIN15.}$$

- 3) The cut-off frequency for Bass-Boost is calculated by the following equations:

$$f_c = 1/(2 \times \pi \times C22-23 \times R22-23) \text{ [Hz]} \quad \text{Where } RC22-23 \text{ is connected between PIN22 and PIN23.}$$

$$f_c = 1/(2 \times \pi \times C14-15 \times R14-15) \text{ [Hz]} \quad \text{Where } RC14-15 \text{ is connected between PIN14 and PIN15.}$$

- 4) Apply power to RCHVCC (PIN13), for MONO only.

### 3. Regulator

- 1) The REG output voltage is calculated by the following equation, and numeric values are shown below:

$$V = 1.15 \text{ [V]} \times (1 + R(VLEV)/R(VREF)) \text{ [V]}$$

REG setting voltage	3.0	3.3	3.6	4.0	4.6	V
Supply voltage(VCC)	3.3	3.6	4.0	5.0	5.0	V
R(VLEV)	30k	30k	30k	30k	30k	Ω
R(VREF)	18k	16k	14k	12k	10k	Ω

Use 1% resistors to eliminate errors in actual output voltages.

- 2) The REG maximum output current is determined by the external Tr capability (hFE) of the IC. If more current is necessary, select one IC MAX with large hFE. Drive output current to the base is about 5 mA.
- 3) When using the regulator, connect REG output to PIN6. The LINE amplifier, BIAS, and other sections essential to tone quality, are driven by the REG voltage. Clear sound output is obtained even if a digital power supply is the VCC.
- 4) When using the regulator for an application, other than this IC, and driving the IC by VCC only, apply VCC at PIN6.
- 5) When not using the regulator, it is set to OFF mode by connecting PIN 19 to OPEN and PIN18 to OPEN. Apply VCC at PIN6.
- 6) Do not set a VCC applied voltage that is smaller than the set voltage of the regulator. Since the REG output transistor operates in a saturation region, an abnormal circuit current occurs.
- 7) For the REG output transistor, Rohm transistors 2SA1900 and 2SA933 are recommended.

## 4. Short circuit detection

## 1) Overview of SP amplifier VCC/GND short circuit detection.

If the output pin of the SP amplifier is short circuited to VCC or GND, the detection function operates to suspend the output stage of the SP amplifier.

If the SP output pin is short circuited to REG output, the detection function does not operate. It is configured so that it resets automatically if the short circuit is canceled. Moreover, although a short circuit is detected from the DC voltage of the output pin, and there is a short delay distinguishing it from maximum output amplitude, malfunction may occur due to factors such as power supply voltage and load. In this case, connect "PIN7" to GND. The short circuit function is set to the OFF mode.

## 2) SP amplifier VCC/GND short circuit detection cautions

When the output pin of the SP amplifier is short circuited with VCC or GND, excessive current flows in the IC and stress is applied to the chip. Accordingly, if it is shorted a number of times, the IC gradually deteriorates and is finally destroyed. The short circuit detection function does not guarantee operation after numerous shorts.

## 3) Regulator short circuit detection

If the output pin of the regulator is short circuited to GND, the detection function operates to suspend the output stage of the regulator. If the output pin of the regulator is short circuited to VCC, an abnormal current does not occur in any circuit. After the short circuit, the regulator resets automatically, due to the pull-up resistance (for example, 2.2 k $\Omega$ ) connected to PIN1, as shown in the full option example of the sample application circuit.

(Example: 3.9 k $\Omega$  is the resistance load for lowering the output impedance of the regulator when it is no load.)

## 5. Pop noise

## 1) The following table shows the sequence for eliminating the pop noise that occurs from turning the power supply ON or OFF, or turning control pins ON or OFF.

Order	VCC	ACT/SPND	SP/HP	Conditions
1	OFF	SUSPEND	HP	Power Supply ON
2	ON	SUSPEND	HP	Turning on in the suspend
3	ON	ACTIVE	HP	SP MUTE~countermeasure
4	ON	ACTIVE	SP+HP	MUTE cancellation~operation
5	ON	ACTIVE	SP+HP	Operation
6	ON	ACTIVE	HP	SP MUTE~counter measure
7	ON	SUSPEND	HP	Turning off in the suspend
8	OFF	SUSPEND	HP	Power Supply OFF

## 2) In speaker MUTE state, pop noise does not occur even when starting or changing modes. It is recommended to use speaker MUTE (headphone) mode during conditions where pop noise can occur.

## 3) Any changes of the components values in the sample application circuit can the effect the pop noise cut-off function.

## 6. Bypass and bias capacitor

## 1) Although this IC is designed so that bypass capacitors are not needed, when bypass capacitors are in fact necessary, place them close to the VCC~GND pins.

## 2) Similarly, place a bias capacitor close to the GND pin.

## 7. Capacitive load drive

## 1) Do not connect a capacitive load to the SP amplifier, HP amplifier, or IC pin. There is a possibility of oscillation.

## 2) Adding RC to the HP amplifier output, as in the sample application circuit, makes the output noise, voltage, and distortion sensitive to oscillation.

8. Pop noise at start/end when switching ACTV/SPND

Pop noise can be suppressed by mode transition due to software as in "Pop noise" above, or by hardware as shown below. This is realized (in SP mode) by forcibly setting HP mode temporarily, using the CR differential circuit.

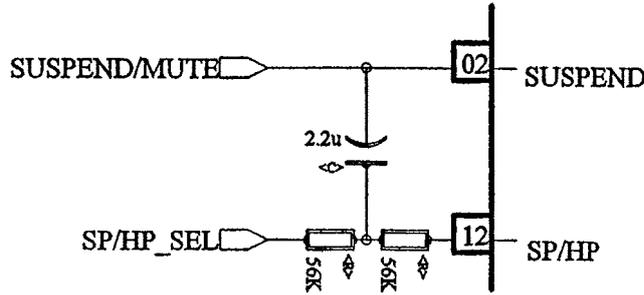


Fig.2

9. Power package

- 1) In order to expand the power dissipation of the package, make the GND pattern, directly below the IC, as wide as possible and solder the GND pattern to the back of the IC.
- 2) Power dissipation of the package varies greatly depending on factors such as the number of layers, area, film thickness, and material quality of the board used.

10. Other

Between voltages of VCC=1.4~1.6 V, momentary oscillation sometimes is observed at the SPOUT pin. Nevertheless, this occurrence is not reproduced on a momentary rise or fall of VCC. When slowly raising VCC pay attention to transient voltage. In order to avoid such occurrences, a sample circuit is illustrated below:

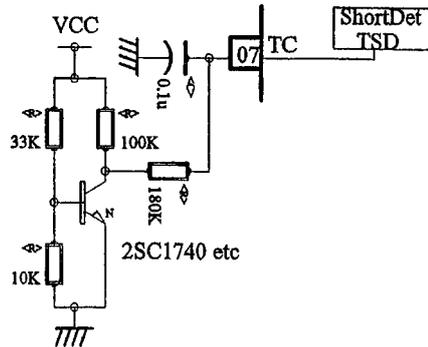


Fig.3

● Application circuit

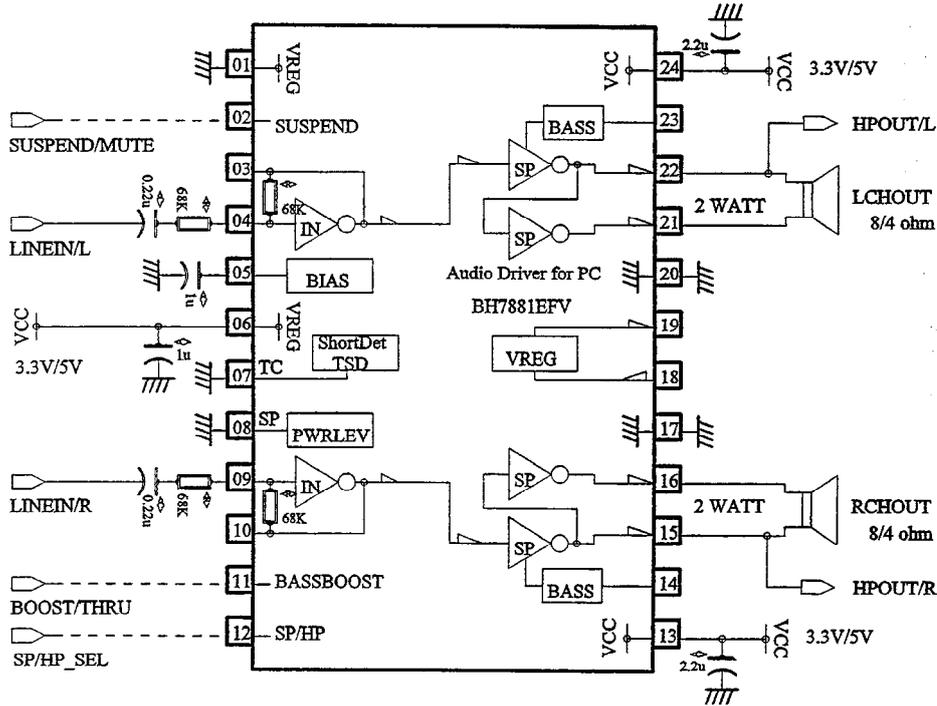


Fig.4 Minimum external components example

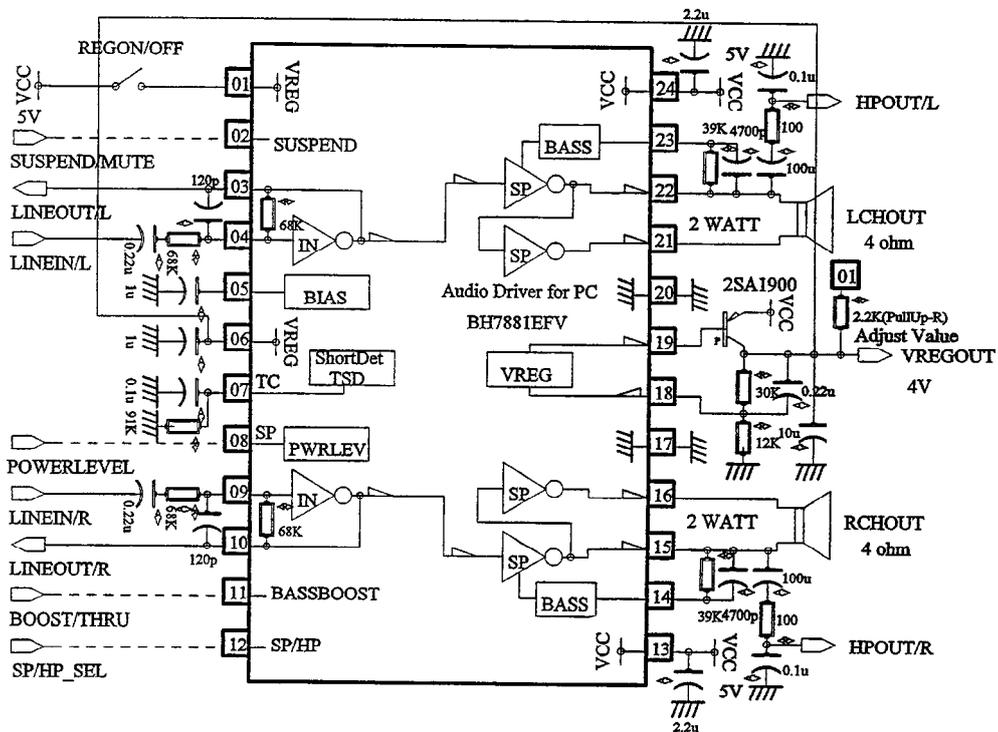


Fig.5 Maximum external components example

**●Operation Notes**

1. Numbers and data in entries are representative design values and are not guaranteed values of the items.
2. Although ROHM is confident that the example application circuit reflects the best possible recommendations, be sure to verify circuit characteristics for your particular application. Modification of constants for other externally connected circuits may cause variations in both static and transient characteristics for external components as well as this Rohm IC. Allow for sufficient margins when determining circuit constants.
3. Absolute maximum ratings  
Use of the IC in excess of absolute maximum ratings, such as the applied voltage or operating temperature range ( $T_{opr}$ ), may result in IC damage. Assumptions should not be made regarding the state of the IC (short mode or open mode) when such damage is suffered. A physical safety measure, such as a fuse, should be implemented when using the IC at times where the absolute maximum ratings may be exceeded.
4. GND potential  
Ensure a minimum GND pin potential in all operating conditions. Make sure that no pins are at a voltage below the GND at any time, regardless of whether it is a transient signal or not.
5. Thermal design  
Perform thermal design, in which there are adequate margins, by taking into account the permissible dissipation (Pd) in actual states of use.
6. Short circuit between terminals and erroneous mounting  
Pay attention to the assembly direction of the ICs. Wrong mounting direction or shorts between terminals, GND, or other components on the circuits, can damage the IC.
7. Operation in strong electromagnetic field  
Using the ICs in a strong electromagnetic field can cause operation malfunction.



## Notes

No copying or reproduction of this document, in part or in whole, is permitted without the consent of ROHM Co.,Ltd.

The content specified herein is subject to change for improvement without notice.

The content specified herein is for the purpose of introducing ROHM's products (hereinafter "Products"). If you wish to use any such Product, please be sure to refer to the specifications, which can be obtained from ROHM upon request.

Examples of application circuits, circuit constants and any other information contained herein illustrate the standard usage and operations of the Products. The peripheral conditions must be taken into account when designing circuits for mass production.

Great care was taken in ensuring the accuracy of the information specified in this document. However, should you incur any damage arising from any inaccuracy or misprint of such information, ROHM shall bear no responsibility for such damage.

The technical information specified herein is intended only to show the typical functions of and examples of application circuits for the Products. ROHM does not grant you, explicitly or implicitly, any license to use or exercise intellectual property or other rights held by ROHM and other parties. ROHM shall bear no responsibility whatsoever for any dispute arising from the use of such technical information.

The Products specified in this document are intended to be used with general-use electronic equipment or devices (such as audio visual equipment, office-automation equipment, communication devices, electronic appliances and amusement devices).

The Products specified in this document are not designed to be radiation tolerant.

While ROHM always makes efforts to enhance the quality and reliability of its Products, a Product may fail or malfunction for a variety of reasons.

Please be sure to implement in your equipment using the Products safety measures to guard against the possibility of physical injury, fire or any other damage caused in the event of the failure of any Product, such as derating, redundancy, fire control and fail-safe designs. ROHM shall bear no responsibility whatsoever for your use of any Product outside of the prescribed scope or not in accordance with the instruction manual.

The Products are not designed or manufactured to be used with any equipment, device or system which requires an extremely high level of reliability the failure or malfunction of which may result in a direct threat to human life or create a risk of human injury (such as a medical instrument, transportation equipment, aerospace machinery, nuclear-reactor controller, fuel-controller or other safety device). ROHM shall bear no responsibility in any way for use of any of the Products for the above special purposes. If a Product is intended to be used for any such special purpose, please contact a ROHM sales representative before purchasing.

If you intend to export or ship overseas any Product or technology specified herein that may be controlled under the Foreign Exchange and the Foreign Trade Law, you will be required to obtain a license or permit under the Law.



Thank you for your accessing to ROHM product informations.  
More detail product informations and catalogs are available, please contact us.

## ROHM Customer Support System

<http://www.rohm.com/contact/>